

[54] HOUSING FOR PRINTED CIRCUIT BOARDS

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[\*\*] Term: 14 Years

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[52] U.S. Cl. .... D13/41; D14/107

[58] Field of Search ..... D14/100-115, D14/52, 57, 58; D13/12, 40, 41; 361/351, 332, 334, 350, 379-384, 390, 391; 174/52 R

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[57] CLAIM

The ornamental design for a housing for printed circuit boards, as shown and described.

DESCRIPTION

FIG. 1 is a top, left side and front perspective view of a housing for printed circuit boards showing my new design, the right side being a mirror image of the left side;

FIG. 2 is a top plan view thereof on a reduced scale, the bottom view being a mirror image;

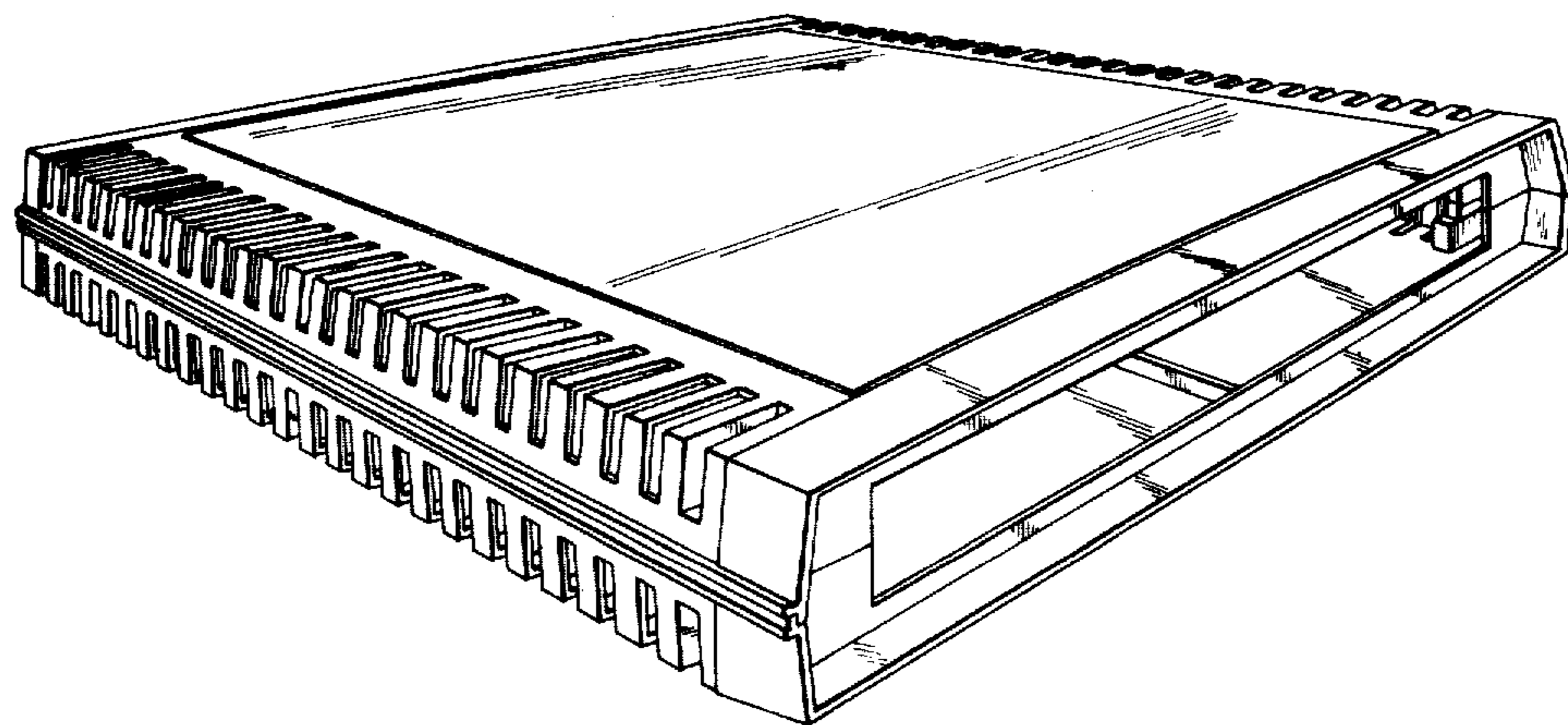
FIG. 3 is a rear elevational view thereof on a reduced scale;

FIG. 4 is a top left side and front perspective view of a second embodiment of my design;

FIG. 5 is a top plan view thereof on a reduced scale, the bottom being a mirror image;

FIG. 6 is a rear elevational view thereon on a reduced scale; and

FIG. 7 is a sectional view on a greatly enlarged scale of the first embodiment taken along line 7-7 in FIG. 2, the second embodiment being similar thereto however including a spacer between the top and bottom sections.



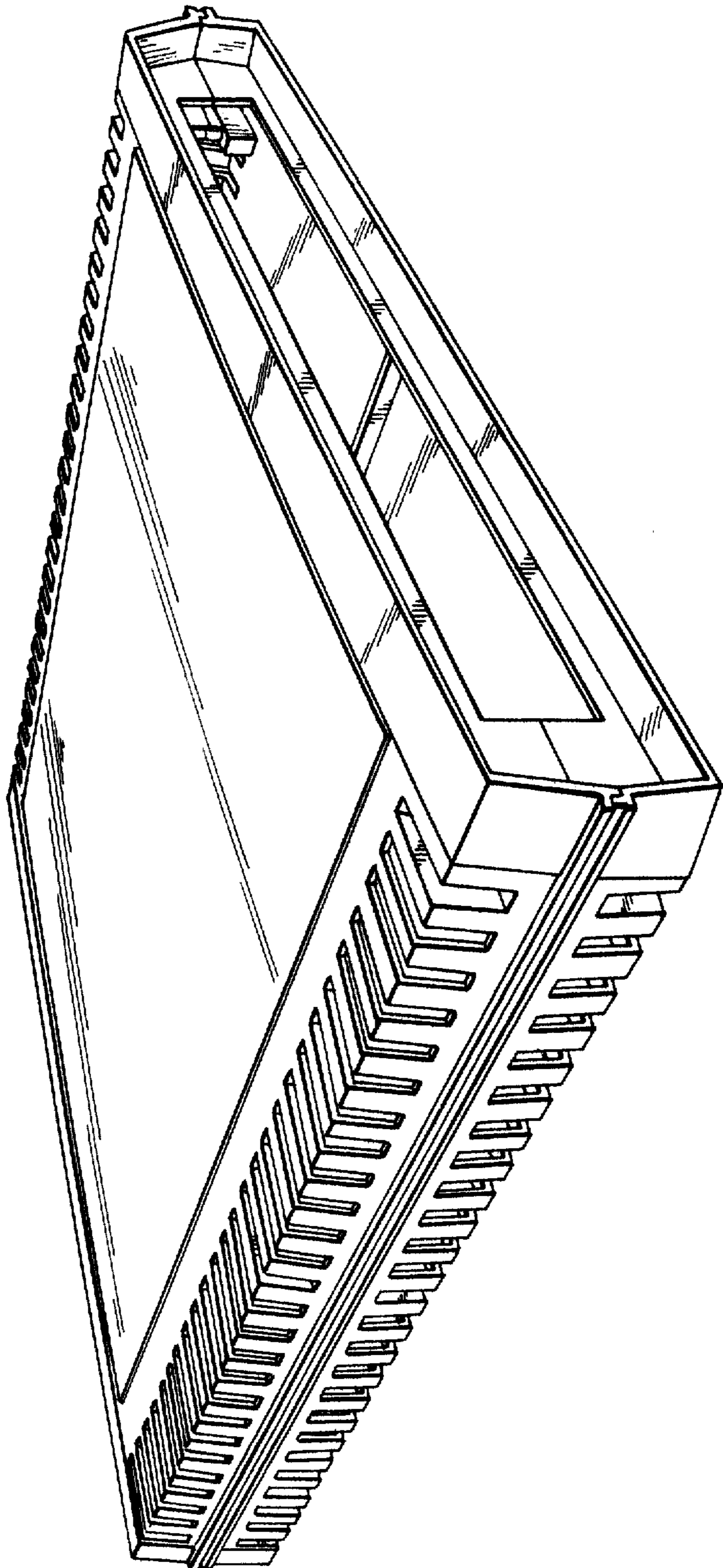


FIG. 1

FIG. 2

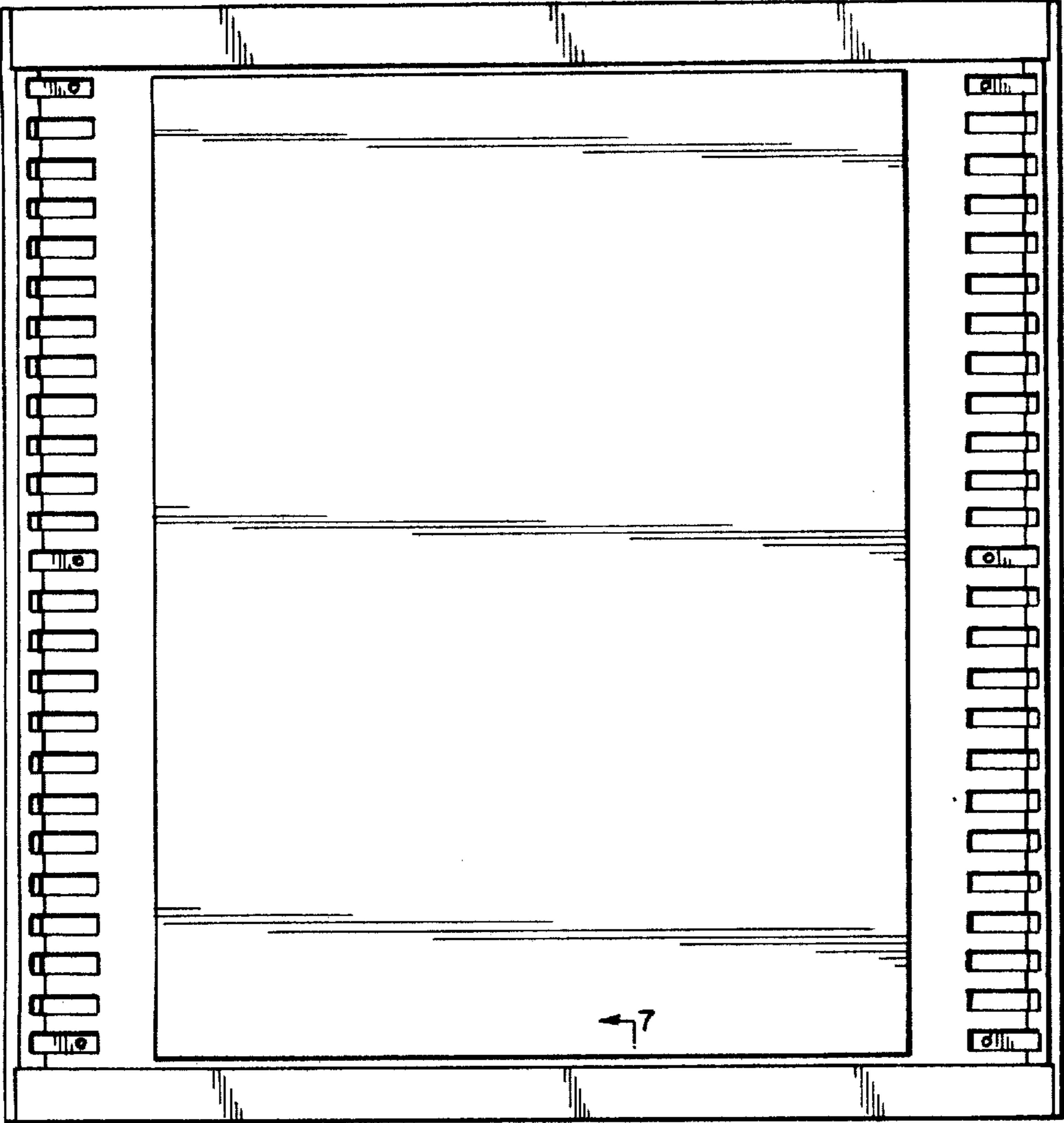
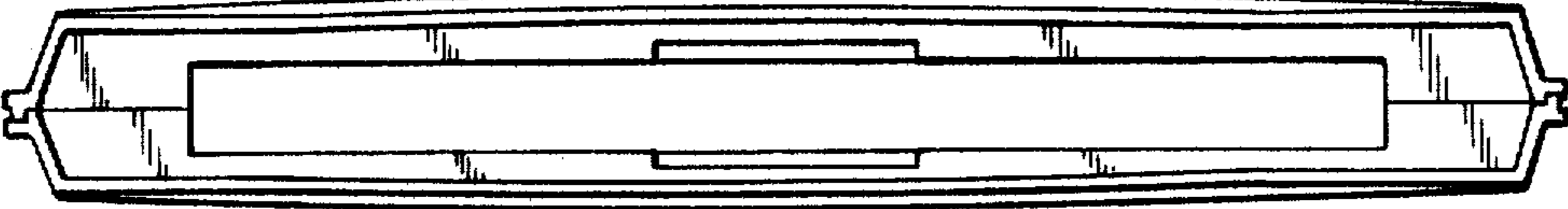


FIG. 3



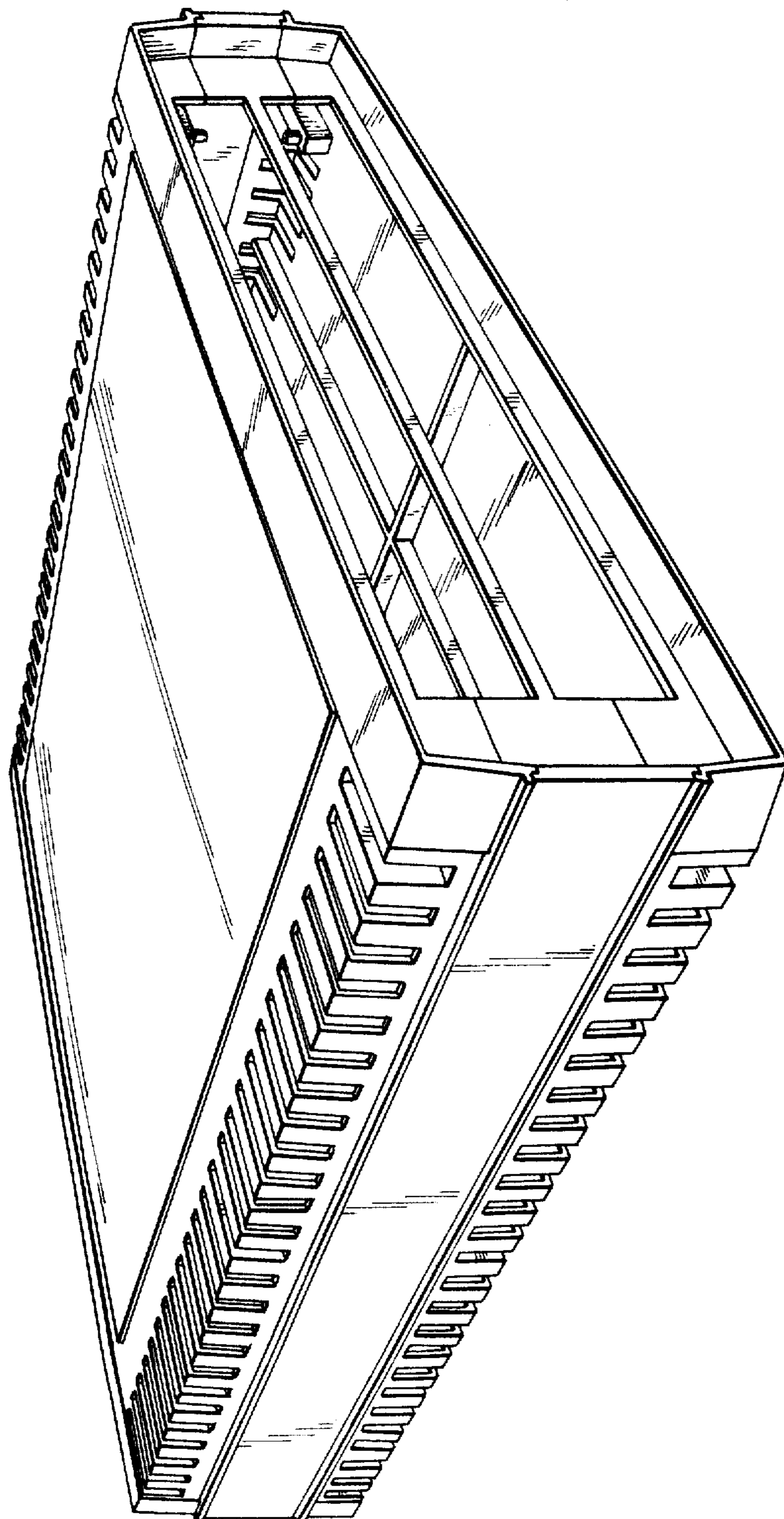


FIG. 4

FIG. 5

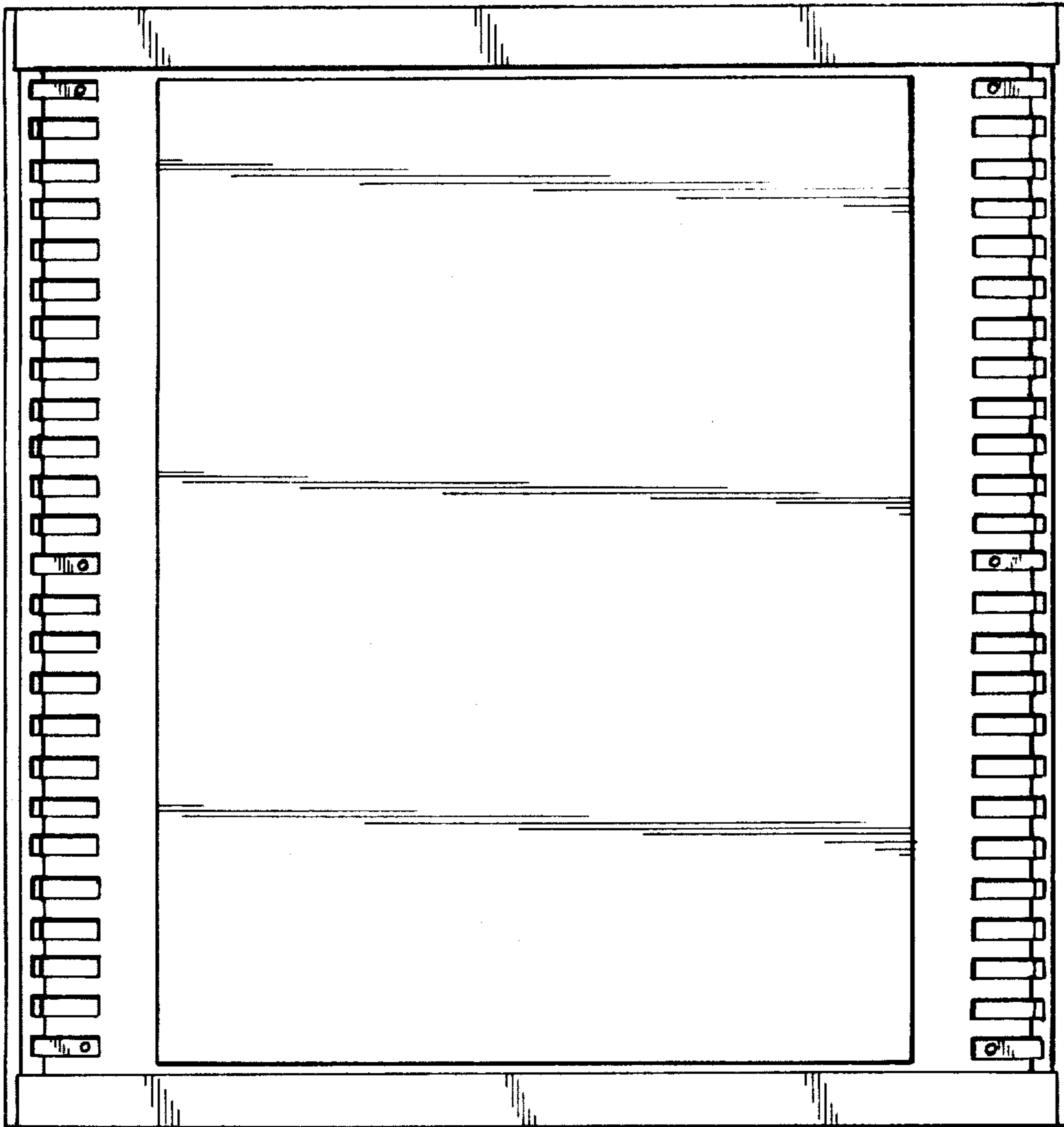
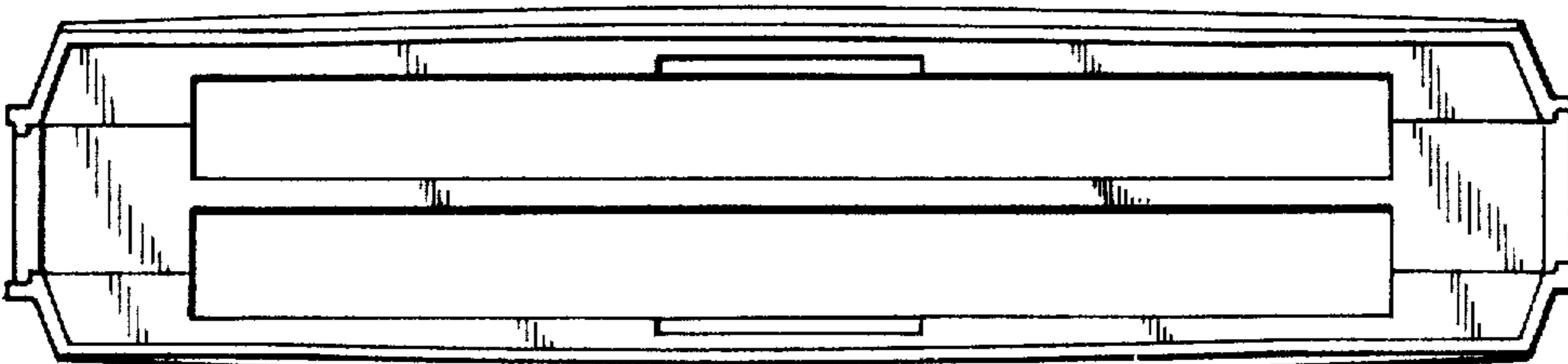


FIG. 6



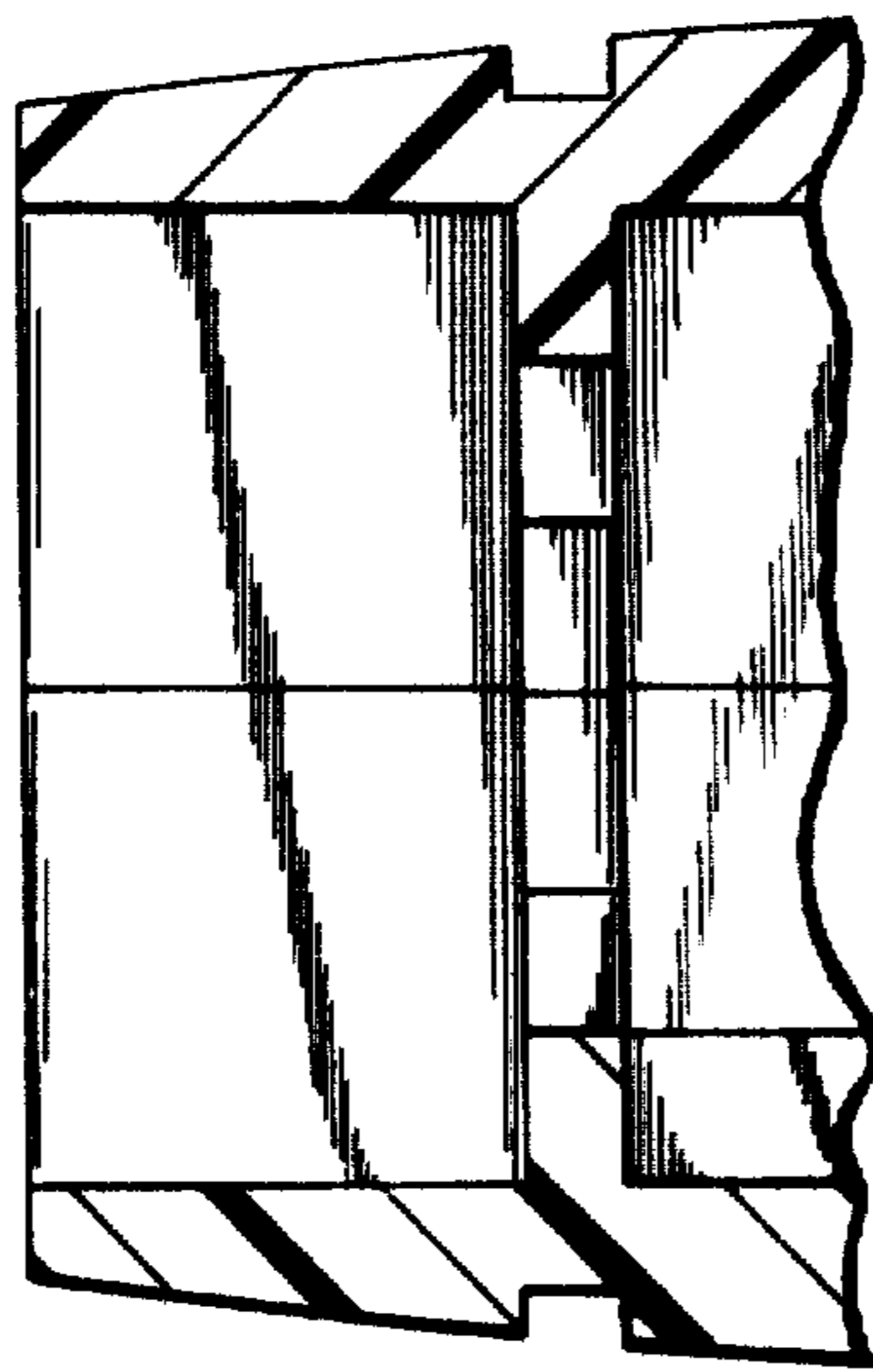


FIG. 7